

SMD 0805, Glass Protected NTC Thermistors



LINKS TO ADDITIONAL RESOURCES



FEATURES

- TCR ranging from -6 %/K at -40 °C to -2 %/K at 150 °C
- Tolerance on R_{25} down to 1 %, and on $B_{25/85}$ down to 1 %
- Suitable for wave or reflow soldering
- NiSn terminations
- Fully glass coated and protected
- cULus recognized, file E148885 (UL category XGPU2 / XGPU8)
- AEC-Q200 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Temperature sensing, protection and compensation in automotive, industrial, telecom and consumer applications. Examples are:
 - Battery chargers
 - Power suppliers
 - Office equipment
 - LCD compensation
 - In-car entertainment

DESCRIPTION

Size 0805 (M2012) glass protected SMD chip thermistor with negative temperature coefficient (TCR) and matte tin (Sn) plated terminations. The device has no marking.

PACKAGING

Available in 8 mm punched paper tape on reel package of 4000 units.

DESIGN-IN SUPPORT

For complete curve computation, please visit: www.vishay.com/thermistors/ntc-curve-list/

QUICK REFERENCE DATA		
PARAMETER	VALUE	UNIT
Resistance value at 25 °C	2.2K to 680K	Ω
Tolerance on R_{25} -value	± 1; ± 2; ± 3; ± 5	%
$B_{25/85}$ -value	3430 to 4125	K
Tolerance on $B_{25/85}$ -value	± 1; ± 3	%
Maximum dissipation at 25 °C	210	mW
Thermal time constant τ	≈ 10	s
Dissipation factor D	3.5	mW/K
Operating temperature range at zero power	-40 to +150	°C
Weight	≈ 0.008	g

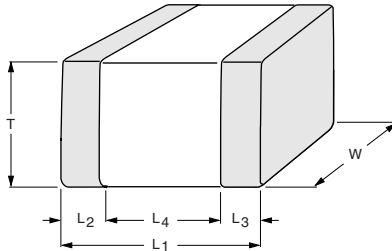
AGENCY APPROVALS

Agency approval documents, please see: www.vishay.com/ppg?29044&documents

ELECTRICAL DATA AND ORDERING INFORMATION				
R_{25} (Ω)	R_{25} -TOL. (± %)	$B_{25/85}$ (K)	$B_{25/85}$ -TOL. (± %)	SAP MATERIAL AND ORDERING NUMBER (1)
2200	1, 2, 3, 5	3600	1	NTCS0805E3222*MT
4700	1, 2, 3, 5	3500	1	NTCS0805E3472*MT
10 000	1, 2, 3, 5	3430	3	NTCS0805E3103*LT
10 000	1, 2, 3, 5	3570	3	NTCS0805E3103*MT
10 000	1, 2, 3, 5	3940	1	NTCS0805E3103*HT
15 000	1, 2, 3, 5	3700	1	NTCS0805E3153*MT
22 000	1, 2, 3, 5	3800	1	NTCS0805E3223*HT
33 000	1, 2, 3, 5	3920	1	NTCS0805E3333*HT
47 000	1, 2, 3, 5	3960	1	NTCS0805E3473*HT
68 000	1, 2, 3, 5	4100	1	NTCS0805E3683*XT
100 000	1, 2, 3, 5	3590	1	NTCS0805E3104*MT
100 000	1, 2, 3, 5	4100	1	NTCS0805E3104*XT
330 000	1, 2, 3, 5	3930	1	NTCS0805E3334*HT
470 000	1, 2, 3, 5	4025	1	NTCS0805E3474*XT
680 000	1, 2, 3, 5	4125	1	NTCS0805E3684*XT

Note

(1) Replace * in SAP material number by J for ± 5 %, H for ± 3 %, G for ± 2 %, F for ± 1 % tolerance on R_{25}

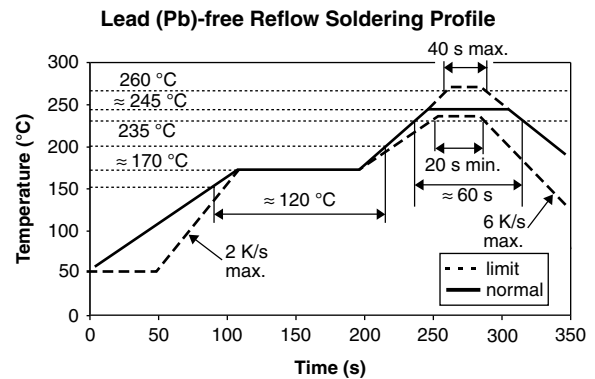
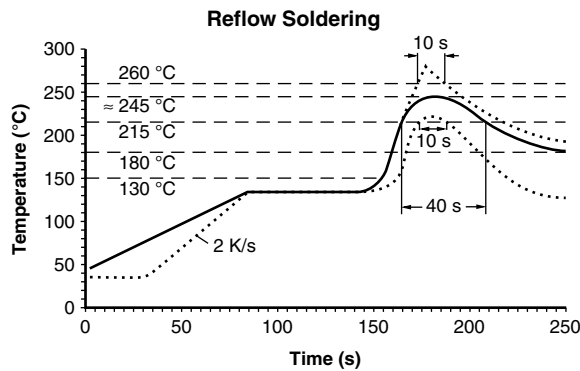
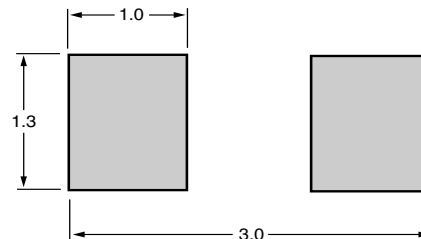
DIMENSIONS


L ₁	W	T	L ₂ AND L ₃ MIN.	L ₄ MIN.
2.0 ± 0.2	1.25 ± 0.15	0.8 ± 0.15	0.2	0.55

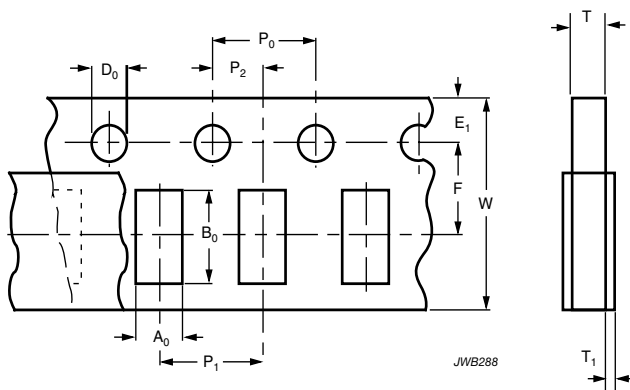
SOLDERING CONDITIONS

This SMD thermistor is only suitable for wave or reflow soldering, in accordance with JEDEC® J-STD-020. The maximum temperature of 260 °C during 40 s should not be exceeded.

Typical examples of a soldering processes that will provide reliable joints without damage, are shown below.


Dimensions of the solder lands

PACKAGING
TAPE SPECIFICATIONS

All tape specifications are in accordance with IEC 60286-3. Basic dimensions are given below. Carrier tape material is paper.

PAPER TAPE


DIMENSIONS OF PAPER TAPE in millimeters	
PARAMETER	DIMENSION
A ₀ ⁽¹⁾	1.7 ± 0.2
B ₀ ⁽¹⁾	2.35 ± 0.1
W	8.0 ± 0.2
E ₁	1.75 ± 0.1
F	3.5 ± 0.05
D ₀	1.55 ± 0.05
P ₀ ⁽²⁾	4.0 ± 0.1
P ₁	4.0 ± 0.1
P ₂	2.0 ± 0.05
T tape thickness max.	1.1
T ₁ cover tape thickness max.	0.1

Notes

⁽¹⁾ Measured 0.3 mm above base pocket

⁽²⁾ P₀ pitch cumulative error over any 10 pitches ± 1.0 mm



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